FMP20N60S1

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET**

Super J-MOS series

N-Channel enhancement mode power MOSFET

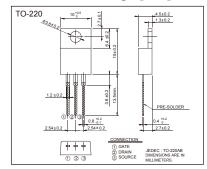
Features

Pb-free lead terminal RoHS compliant

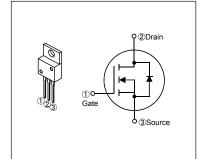
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



Maximum Ratings and Characteristics

● Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks	
Drain Course Voltage	V _{DS}	600	V		
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V	
Continuous Drain Current	lo	±20	Α	Tc=25°C Note*1	
Continuous Drain Current		±12.6	Α	Tc=100°C Note*1	
Pulsed Drain Current	IDP	±60	Α		
Gate-Source Voltage	V _G s	±30	V		
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	6.6	Α	Note *2	
Non-Repetitive Maximum Avalanche Energy	Eas	472.2	mJ	Note *3	
Maximum Drain-Source dV/dt	dV _{DS} /dt	50	kV/μs	V _{DS} ≤ 600V	
Peak Diode Recovery dV/dt	dV/dt	15	kV/μs	Note *4	
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5	
Maximum Power Dissipation	Pp	2.02	W	T _a =25°C	
	PD	150	VV	Tc=25°C	
Oneveting and Stayone Townsystone years	Tch	150	°C		
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C		

Note *1 : Limited by maximum channel temperature.

Note *1: Limited by maximum channel temperature. Note *2: T_{rb}≤150°C, See Fig.1 and Fig.2 Note *3: Starting T_{ch}=25°C, I_s=2A, L=216mH, V_{DD}=60V, R_c=50 Ω , See Fig.1 and Fig.2 Eas limited by maximum channel temperature and avalanche current. Note *4: I_F≤-I_D, -di/dt=100A/ μ s, V_{DD}≤400V, T_{ch}≤150°C. Note *5: I_F≤-I_D, dV/dt=15kV/ μ s, V_{DD}≤400V, T_{ch}≤150°C.

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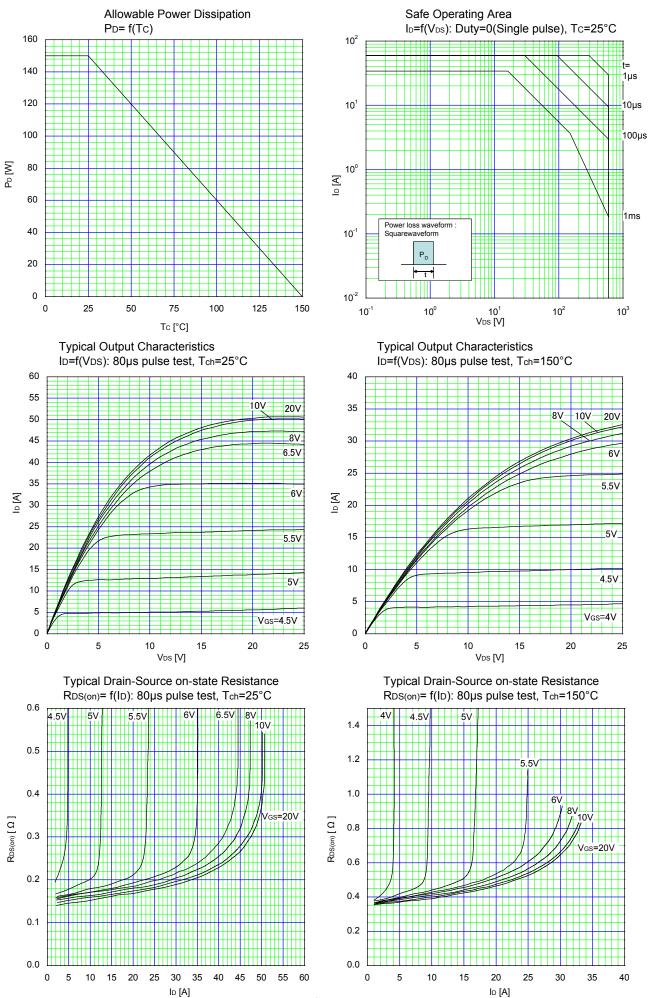
● Electrical Characteristics at T₀=25°C (unless otherwise specified) Static Ratings

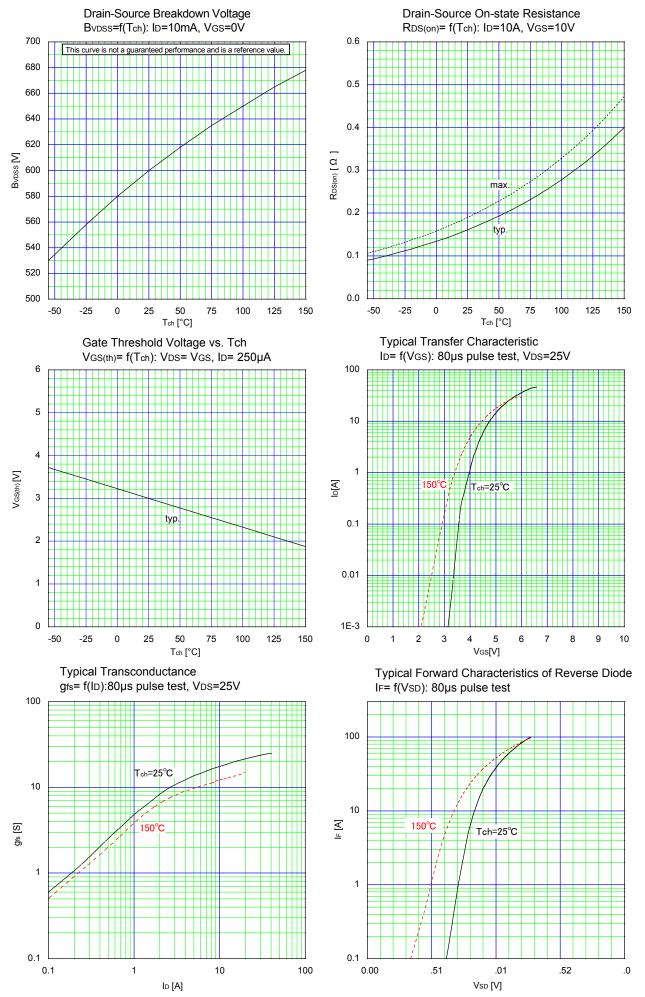
Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250μA V _{DS} =V _{GS}		2.5	3	3.5	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μA
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	Icss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =10A V _{GS} =10V		-	0.161	0.19	Ω
Gate resistance	R _G	f=1MHz, open drain		-	3.7	-	Ω
Forward Transconductance	gfs	I _D =10A V _{DS} =25V		8.5	17.5	-	S
Input Capacitance	Ciss	V _{DS} =10V		-	1470	-	
Output Capacitance	Coss	V _{GS} =0V		-	3120	-	pF
Reverse Transfer Capacitance	Crss	f=1MHz	f=1MHz		280	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V V _{GS} =0V V _{DS} =0480V ID=constant		-	90	-	
Effective output capacitance, time related (Note *7)	C _{o(tr)}			-	305	-	
T 0.1 T'	t _{d(on)}	V _{DD} =400V, V _{GS} =10V I _D =10A, R _G =27Ω See Fig.3 and Fig.4		-	22	-	ns
Turn-On Time	tr			-	40	-	
T Off Time	t _{d(off)}			-	162	-	
Turn-Off Time	tf			-	22	-	
Total Gate Charge	Q _G	V _{DD} =480V, I _D =20A V _{GS} =10V See Fig.5		-	48	-	nC
Gate-Source Charge	Q _{GS}			-	12.5	-	
Gate-Drain Charge	Q _{GD}			-	15	-	
Drain-Source crossover Charge	Qsw			-	8	-	
Avalanche Capability	lav	L=6.02mH, Tch=25°C See Fig.1 and Fig.2		6.6	-	-	А
Diode Forward On-Voltage	V _{SD}	I _F =20A, V _{GS} =0V T _{ch} =25°C		-	0.9	1.35	V
Reverse Recovery Time	trr	I _F =20A, V _{GS} =0V			370	-	ns
Reverse Recovery Charge	Qrr	- V _{DD} =400V -di/dt=100A/μs - T _{ch} =25°C See Fig.6		-	6.2	-	μC
Peak Reverse Recovery Current	Irp			-	32	-	А

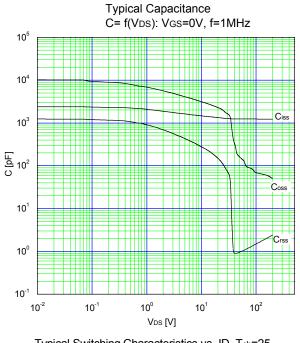
Note *6 : $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% BVpss. Note *7 : $C_{o(tr)}$ is a fixed capacitance that gives the same charging times as C_{oss} while V_{DS} is rising from 0 to 80% BVpss.

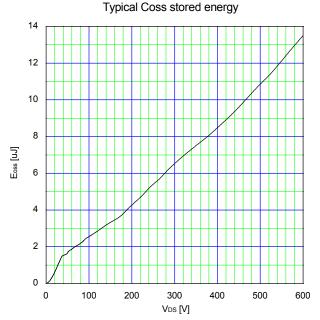
Thermal Characteristics

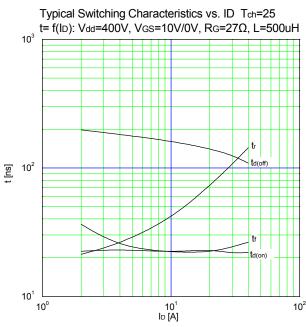
Description	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}			0.83	°C/W
Channel to Ambient	Rth/ch-a)			62	°C/W

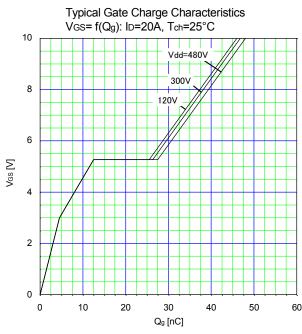


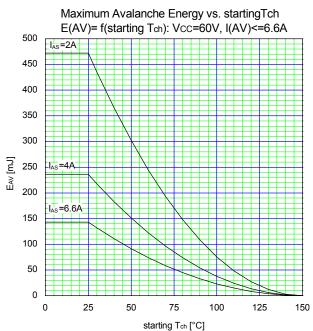


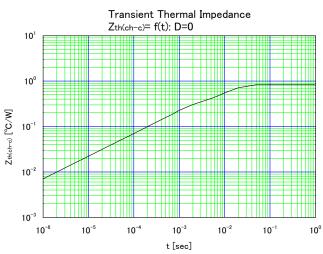












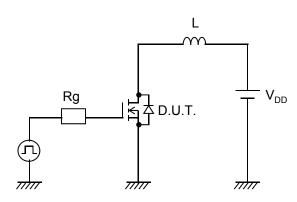


Fig.1 Avalanche Test circuit

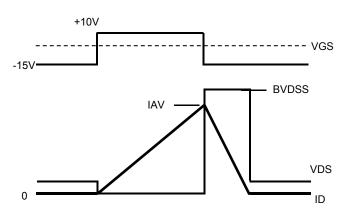


Fig.2 Operating waveforms of Avalanche Test

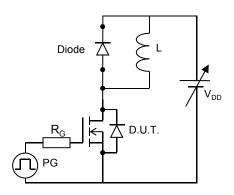


Fig.3 Switching Test circuit

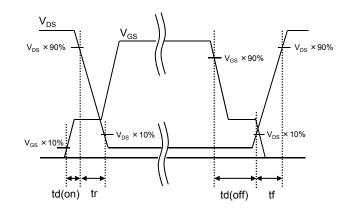


Fig.4 Operating waveform of Switching Test

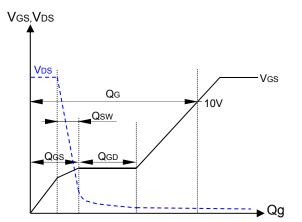


Fig.5 Operating waveform of Gate charge Test

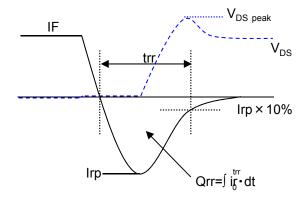
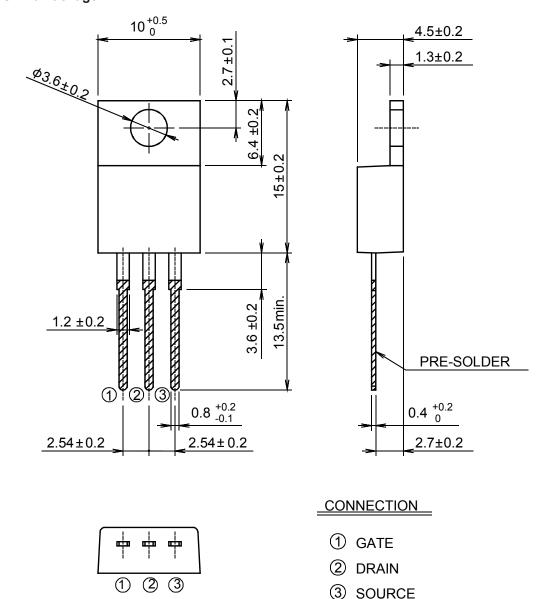
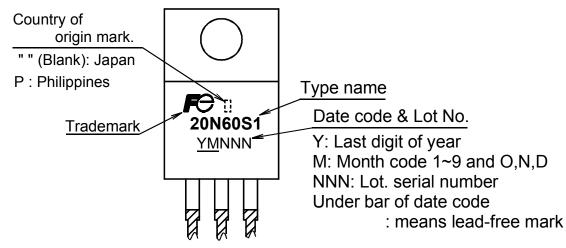


Fig.6 Operating waveform of Reverse recovery Test

Outview: TO-220 Package



Marking



^{*} The font (font type,size) and the trademark-size might be actually different.

JEDEC: TO-220AB

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